



PRODUCT SPECIFICATIONS Module No.: PV043023Y0120T

General Specification

- 4.3 inch Diagonal
- 800 \times RGB \times 480 resolution
- 3-wire SPI、 4-wire SPI、 QSPI interface
- LED Blacklight (1000cd/m2)
- 16.7 M colors
- IPS/ALL Optimal View
- RoHS Compliant

From: Kingtech Group Co.,Ltd

<u> </u>		
DESIGNED	CHECKED	Approved
研发部 2023.06.05 Aleck	研发部 2023.06.05 Hones	研发部 2023.06.05 Mike

For Customer's Acceptance:

Comments:	Approved by:





REV NO.	REV DATE	CONTENTS	Note
V0	2023.06.05	NEW ISSUE	





Table of Contents

	Cover	1
	Revision Record	2
	Table of Contents	3
1	Scope	4
2	General Information	4
3	External Dimensions	5
4	Module Structure	6
5	Absolute Maximum Ratings	8
6	DC Characteristics	8
7	Timing Characteristics	9
8	Backlight Characteristics	10
9	Optical Characteristics	10
10	Reliability Test Conditions and Methods	13
11	Inspection Standard	14
12	Handling Precautions	18
13	Precaution for Use	19
14	Packing Method	19





1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by Kingtech Group Co.,Ltd

2. General Information

LCM

ITEM	STANDARD VALUES	UNIT
LCD Type	4.3"TFT	-
Dot Arrangement	800(RGB)×480	dots
Color Filter Array	RGB vertical stripe	-
Display mode	Normally BLACK IPS	-
Viewing Direction	ALL	-
Module Size	120.0(W)×86.2(H)×4.6(T)	mm
Active Area	95.04(W)×53.86(H)	mm
Interface	3-wire SPI、4-wire SPI、QSPI interface	-
Operating Temperature	-20 ~ +70	°C
Storage Temperature	-30 ~ +80	°C
Back Light	16 White LEDS	-



 Professional LCD Module Manufacturer since 2003

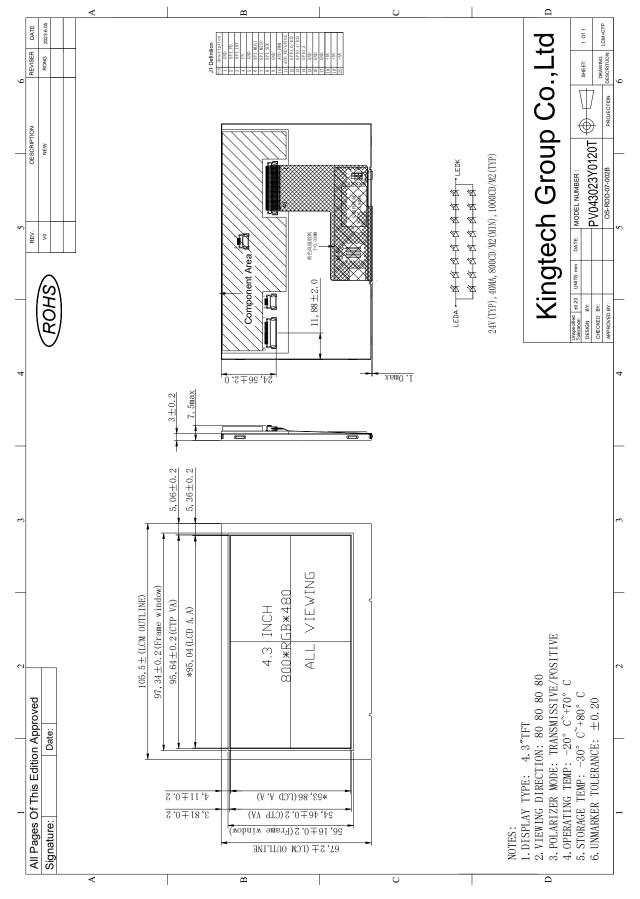
 Tel: 86-755-23037763

 Image: Mobile: 86-139-2528-0716

 Image: Web : www.kingtechlod.com



3. External Dimensions





4. Module Structure 4.1 Pin Description

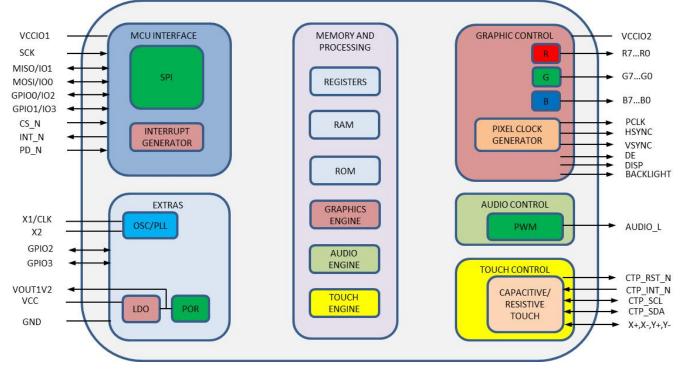
PIN	PIN NAME	DESCRIPTION
1	GND	Power ground
2	SPI_PD	Chip power down mode control input, active low.
3	SPI_INT	Interrupt to host, open drain output(default) or push-pull output, active low.
4	CS	SPI slave select input
5	GND	Power ground
6	SPI_MOSI	SPI Single mode: SPI MOSI input SPI Dual/Quad mode: SPI data line 0
7	SPI_MISO	SPI Single mode: SPI MISO output SPI Dual/Quad mode: SPI data line 1
8	SPI_SCK	SPI clock input
9	GND	Power ground
10	AUD_PWM	Audio PWM out
11	AUD_PD/GPIO2	General purpose IO 2
12	GPIO_0/IO2	SPI Single/Dual mode: General purpose IO 0 SPI Quad mode: SPI data line 2
13	GPIO_1/IO3	SPI Single/Dual mode: General purpose IO 1 SPI Quad mode: SPI data line 3
14	GPIO_3	General purpose IO 3
15	GND	Power ground
16	GND	Power ground
17	GND	Power ground
18	+5V	supply voltage to the analog circuit.
19	+5V	supply voltage to the analog circuit.
20	+5V	supply voltage to the analog circuit.





4.2 Block Diagram

FT813 with EVE (Embedded Video Engine) technology simplifies the system architecture for advanced Human Machine Interfaces (HMIs) by providing support for display, touch, and audio as well as an object oriented architecture approach that extends from display creation to the rendering of the graphics.



4.3 Serial Host Interface

By default the SPI slave operates in the SINGLE channel mode with MOSI as input from the master and MISO as output to the master. DUAL and QUAD channel modes can be configured through the SPI slave itself. To change the channel modes, write to register REG_SPI_WIDTH. Please refer to the table below:

REG_SPI_WIDTH[1:0]	Channel Mode	Data Pins	Max Bus Speed
00	SINGLE(default)	MISO, MOSI	30MHz
01	DUAL	IO0, IO1	30MHz
10	QUAD	IO0, IO1, IO2 IO3	25MHz
11	Reserved	-	-

For more details on the FT81X SPI interface, please refer to pages 13-15 of the official FT81x Datasheet:

http://www.ftdichip.com/Support/Documents/DataSheets/ICs/DS_FT81x.pdf

For the REG_SPI_WIDTH register definition, please refer to page 87 of the official FT81x Series Programmers Guide:

http://www.ftdichip.com/Support/Documents/ProgramGuides/FT81X_Series_Programmer_Guide.pdf





5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Input Voltage	+5V	-0.3	6.0	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C

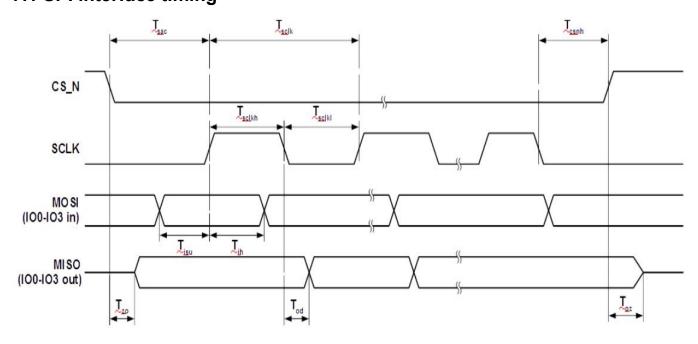
6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Analog Supply Voltage	+5V	4.5	5.0	5.5	V	-
Input High Voltage	Vih	2.0	-	3.3	V	-
Input Low Voltage	V _{IL}	GND	-	0.8	V	-
Output High Voltage	V _{OH}	2.9	-	3.3	V	-
Output Low Voltage	Vol	GND	-	0.4	V	-
Supply Current	I _{+5V}		500	650	mA	+5V= 5V





7. Timing Characteristics 7.1 SPI interface timing



Parameter	Description	Min	Max	Units
Tsclk	SPI clock period(SINGLE/DUAL mode)	33.3	-	ns
Tsclk	SPI clock period (QUAD mode)	13	-	ns
Tsclkl	SPI clock low duration	13	-	ns
Tsclkh	SPI clock high duration	13	-	ns
Tsac	SPI access time	3	-	ns
Tisu	Input Setup	3	-	ns
Tih	Input Hold	0	-	ns
Tzo	Output enable delay	-	11	ns
Toz	Output disable delay	-	10	ns
Tod	Output data delay	-	11	ns
Tcsnh	CSN hold time	0	-	ns



7.2 Timing Table

	Parallel 24-bit RGB Interface Timing Table								
Item		Symbol	Min.	Тур.	Max.	Unit	Remark		
DCLK Fre	equency	Fclk	23	25	27	MHz			
	Period Time	Th	808	816	896	DCLK			
	Display Period	Thdisp		800		DCLK			
HSYNC	Back Porch	Thbp	4	8	48	DCLK			
	Front Porch	Thfp	4	8	48	DCLK			
	Pulse Width	Thw	2	4	8	DCLK			
	Period Time	Τv	488	496	504	HSYNC			
	Display Period	Tvdisp		480		HSYNC			
VSYNC	Back Porch	Tvbp	6	8	12	HSYNC			
	Front Porch	Tvfp	6	8	12	HSYNC			
	Pulse Width	Tvw	2	4	8	HSYNC			

8. Backlight Characteristic

Item	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity for LCM and TP	-	800	1000	-	cd/m ²	+5V= 5V
Uniformity for LCM	-	80	-	-	%	
Lifetime	-	30,000	-	-	Hr	
Backlight Color	White					

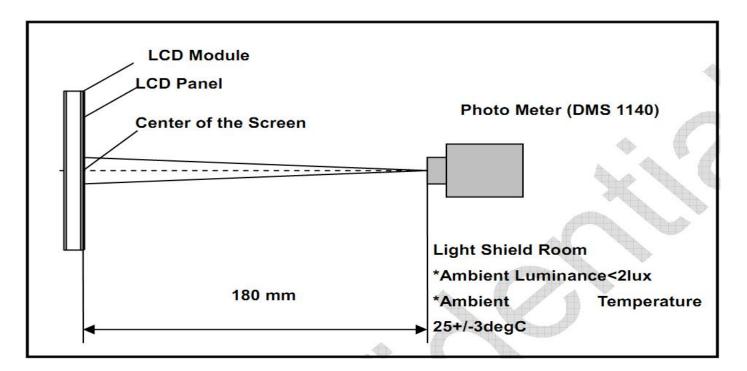




9. Optical Characteristics

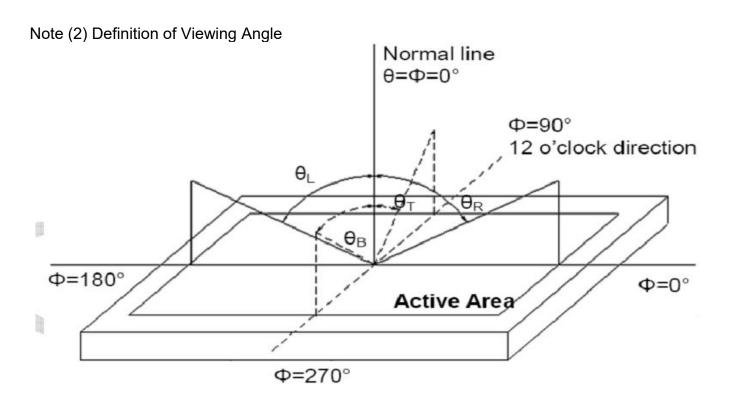
Item	Conditions		Min.	Тур.	Max.	Unit	Note
Viewing Angle (CR>10)	Horizontal	θL	-	80	-	degree	(1),(2),(6)
		θR	-	80	-		
	Vertical	θт	-	80	-		
		θв	-	80	-		
Contrast Ratio	Center		-	1200	-	-	(1),(3),(6)
Response Time	Rising + Falling			35	40	ms	(1),(4),(6)
	Red x			0.600	-	-	(1) (6)
	Red y			0.370		-	
	Green x			0.340		-	
CF Color	Green y			0.600		-	
Chromaticity (CIE1931)	Blue x		Тур.	0.150	Тур.	-	(1), (6)
	Blue y		-0.05	0.115	+0.05	-	
	White x			0.310		-	
	White y			0.329		-	
NTSC			-	50	-	%	(1),(6)

Note (1) The electro-optical response time measurements shall be made as FIGURE 5 shown in Appendix by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Td, and 90% to 10% is Tr.









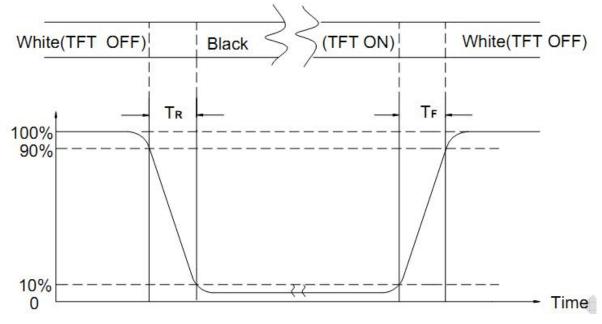
Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input) Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD





10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST	
1)	High Temperature Storage	80°C±2°C×96Hours		
2	Low Temperature Storage	-30°C±2°C×96Hours		
3	High Temperature Operating	70°C±2°C×96Hours	Inspection after 2~4hours	
4	Low Temperature Operating	-20°C±2°C×96Hours	storage at room temperature, the samples should be free from	
5	Temperature Cycle(Storage)	-20°C (30min) 25°C (5min) (30min) 1cycle Total 10cycle	 defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display. 4, Missing segments. 5, Glass crack. 6, Current IDD is twice higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements 	
6	Damp Proof Test (Storage)	50°C±5°C×90%RH×96Hours		
7	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5MM X,Y,Z direction for total 3hours (packing condition test will be tested by a carton)		
8	Drooping Test	Drop to the ground from 1M height one time every side of carton. (packing condition test will be tested by a carton)	shall be satisfied.	
9	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Ai r Mode,10times		

REMARK:

1, The Test samples should be applied to only one test item.

2, Sample side for each test item is 5~10pcs.

3,For Damp Proof Test, Pure water(Resistance > $10M\Omega$)should be used.

4,In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.

5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.

6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

7.1 \sim 6 test exclude Polaroid





11. Inspection Standards

11.1. Quality

The quality of goods supplied to purchaser shall come up to the following standards:

11.1.1. Inspection Tools and Instruments

Vernier calipers, film scales, multimeter, magnifying eyepiece, ND5%, luminance meter and so on.

11.1.2. The Method of Preserving Goods

After delivery of goods from KINGTECH to purchaser, purchaser shall keep the LCM at -10°C to 30°C, and it might be desirable to keep at the normal room temperature and humidity until incoming inspection or throwing into process line.

11.1.3. Incoming Inspection

(A) The methods of Inspection

If purchaser makes an incoming inspection, a sampling plan shall be applied on the condition that quality of one delivery shall be regarded as one lot. (B) The standard of quality:

ISO-2859-1 (same as MIL-STD-105E), Level: II				
CLASS	AQL (%)			
Critical	0.4 %			
Major	0.65 %			
Minor	1.5 %			

. ..

Every item shall be inspected according to the class.

(C) Measure

If as the result of above receiving inspection, a lot out is discovered, purchaser Shall inform seller of it within seven days. But first shipment within fourteen days.

11.1.4. Warranty Policy

KINGTECH will provide one-year warranty for the products only if under Specification operating conditions. KINGTECH will replace new products for these defect products which are under warranty period and belong to the responsibility of KINGTECH.

11.2. Checking Condition

- **11.2.1** Checking direction shall be in the 45 degree area to face the sample.
- 11.2.2 Inspector shall see from over 300±25mm with bare eyes far from the sample.

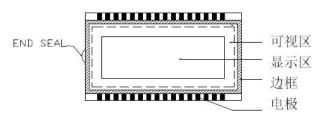
11.2.3 Ambient Illumination:

0 ~30 Lux for functional inspection $500 \sim 1200$ Lux for external appearance inspection.





11.2.4 Test Area:



- **11.2.5** Inspection should be carried out with rope electrostatic ring and static finger cover (both hands except small fingers must be worn)
 - **11.2.6** The inspector may make a visual inspection or a comparative examination with a film ruler and a magnifying eyepiece. Individual defects shall be determined according to the limited samples.
 - **11.2.7** Functional testing uses electrical testing fixtures or test fixtures required by customers.
 - **11.2.8** The ion fan should be used when testing.

11.2.9 The principle of judgement:

- 11.2.9.1 If the defect outside the visual area does not affect the assembly and display, it will be judged as a good product.
- 11.2.9.2 Poor definition: **Pixel:** A combination of three sub-pixels (Red + Green + Blue).

Dot:

Any of the sub-pixels (Red or Green or Blue).

Bright and dark dots:

A point pixel (sub-pixel: R, G, B pixels) is lit or turned off during the display function test.

Highlights:

Usually considered to be shown on a black screen.

Dark spots:

They are generally considered to be shown on R, G, B solid colors or white images.

Neighborhood:

Two or three adjacent point pixels (dot: sub-pixel) connected together (R, G or G, B or B, R or RGB).





11.3. INSPECTION PLAN :

CLASS	ITEM	JUDGEMENT	CLASS
OLAGO	TIEM .	JODGEMENT	ULAGO
	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO.", "LOT NO." AND "QUANTITY"	Minor
PACKING &		SHOULD INDICATE ON THE PACKAGE.	
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
-	4. DIMENSION,	ACCORDING TO SPECIFICATION OR	
ASSEMBLY	LCD GLASS SCRATCH AND SCRIBE DEFECT.	DRAWING.	Major
APPEARANCE	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREA REJECTED	Minor
	6. BLEMISH & BLACK SPOT & WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	7. BLEMISH • BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
9. LCD'S RAINBOW COLO	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST: VOP : CHROMATICITY ETC)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT · LINE · CHARACTER REJECTED	Critical
	12.SHORT CIRCUIT WRONG PATTERN DISPLAY	NO DISPLAY - WRONG PATTERN DISPLAY - CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)		Minor





11.4. STANDARD OF VISUAL INSPECTION

NO.	CLASS	ITEM		л	UDGEMENT	
			(A) ROUND TYPE: unit: mm			
MINOR			DIA	AMETER (mm.)	ACCEPTABLE Q'TY	
			Ø≤0. 1		Disregard	
		BLACK AND WHITE SPOT FOREIGN MATERIEL	$0.2 < \emptyset \le 0.3$		2 (Distance ≥ 5mm)	
	DUST IN THE CELL	$0.3 < \emptyset$		0		
11. 4. 1		BLEMISH	NOTE: $\emptyset = (\text{LENGTH}*\text{WIDTH})/2$			
	SCRATCH	(S) LINE	E TYPE:	unit: mm		
			LENGTH WIDTH		ACCEPTABLE QTY	
			•••••	₩≤ 0.03	3 Disregard	
			L ≤5.0	$0.03 < W \le 0.00$	07 3 (Distanced \geq 5mm	
			•••••	0.07 < W	FOLLOW ROUND TYPE	
			NOTE: Ø	=(LENGTH * WIDTH)/2	2	
					unit: mm.	
11 4 0	MINOD	BUBBLE IN POLARIZER	DIAMETER		ACCEPTABLE Q'TY	
11. 4. 2	MINOR	DENT ON POLARIZER	Ø<0.15		Disregard	
				0.2<Ø≤ 0.3	2(Distance≥ 5mm)	
				0. 3<Ø	0	
				[tems	ACC. Q'TY	
			Br	right dot Dark dot	$\begin{array}{l} N \leq 1 (\text{Distance} \geq 5 \text{mm}) \\ N \leq 2 (\text{Distance} \geq 5 \text{mm}) \end{array}$	
11. 4. 3	MINOR	Dot Defect	Pixel Define : Pixel Define : Pixel Pix			
11. 4. 3. 1	MINOR	Mura	Not visible through 5% ND filter in 50% gray or judge b limit sample if necessary			





NO.	CLASS	ITEM	JUDGEMENT
11.4.5	MINOR	LCD GLASS CHIPPING	X≥3mm Y>S Reject
11.4.6	MINOR	LCD GLASS CHIPPING	X or Y > S Reject
11.4.7	MAJOR	LCD GLASS GLASS CRACK	T T T T T T T T T T T T T T T T T T T
11.4.8	MAJOR	LCD GLASS SCRIBE DEFECT	A [±] ACCORDING TO DIMENSION
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	$Y < 1/2Z$ $Y \ge 0.5mm_{Reject}$ $X \ge 3mm$
11.4.10	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	$Y < 1/2Z$ $Y \ge 0.5mm$ $Reject$ $X \ge 3mm$
11.4.11	MINOR	LCD GLASS CHIPPING	$X \ge 3mm$ $Y \ge T$ $Y \ge T$ $Y \ge T$ If touch the electrode lines, the need to retain the two-thirds electrode lines



12. Handling Precautions 12.1 Mounting method

The LCD panel of KINGTECHTFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

- [Recommended below] and wipe lightly
- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to power or ground, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.





12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to KINGTECHTFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

TBD